AN —1356 LM2743 Evaluation Board

1 Introduction

This application notes describes the LM2743 printed circuit board (PCB) design and provides an example typical application circuit. The demo board allows component design flexibility in order to demonstrate the versatility of the LM2743 IC.

The demo board contains a voltage-mode, high-speed synchronous buck regulator controller. Though the control sections of the IC are rated for 3 to 6V (V_{CC}), the driver sections are designed to accept input supply rails (V_{IN}) as high as 14V.

The demo board design regulates to an output voltage of 1.2V at 3.5A with a switching frequency of 1MHz. Note, the demo board is optimized for a 1MHz, 14V input voltage compensation design, if another switching frequency and input voltage is desired, please consult the LM2743 data sheet for control loop compensation procedures. For additional design modifications refer to the Design Consideration section of the *LM2743 Low Voltage N-Channel MOSFET Synchronous Buck Regulator Controller Data Sheet* (SNVS276). The PCB is designed on two layers with 1oz. copper on a 62mil FR4 laminate.

2 Additional Footprints

A Schottky diode footprint (D1) is available in parallel to the low side MOSFET. This component can improve efficiency, due to the lower forward drop than the low side MOSFET body diode conducting during the anti-shoot through period. Select a Schottky diode that maintains a forward drop around 0.4 to 0.6V at the maximum load current (consult the I-V curve). In addition select the reverse breakdown voltage to have sufficient margin above the maximum input voltage.

Footprint C13 is available for a multilayer ceramic capacitor (MLCC) connected as close as possible to the source of the low side MOSFET and drain of the high side MOSFET. This will provide low supply impedance to the high speed switch currents, thus minimizing the input supply noise. For example; a MLCC is used (C13) in combination with aluminum electrolytic input filter capacitors, placed in designators C12 and C14, because MLCC have lower impedance than electrolytics. If MLCCs are used in designators C12 and C14 then component C13 is not necessary.

3 Typical Application Circuit

The typical application circuit in Figure 1 provides the component designators used on the demo board.

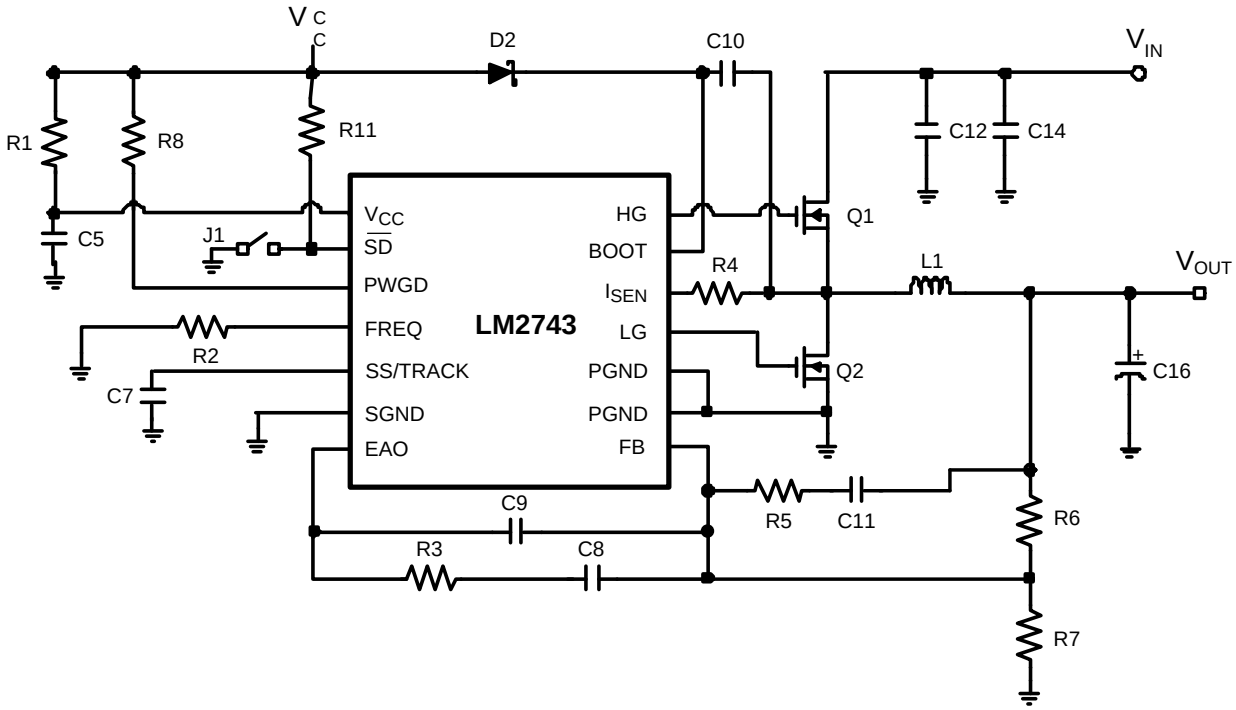

Figure 1. Typical Application

4 Performance Characteristics

4.1 Switch Node Voltage and Output Ripple Voltage

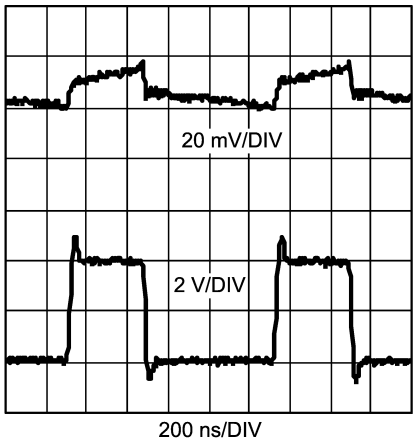

Figure 2. V_{IN} = V_{CC} = 3.3V, V_{OUT} = 1.2V, I_{LOAD} = 0A, f_{SW} = 1MHz. 20 MHz Bandwidth Limit

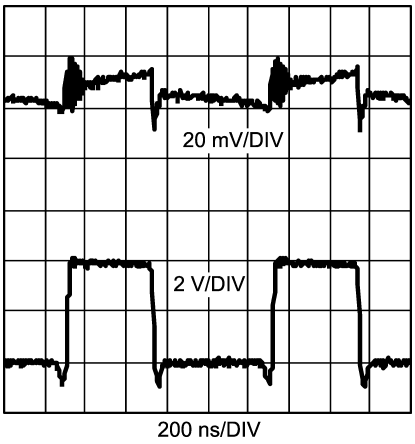

Figure 3. V_{IN} = V_{CC} = 3.3V, V_{OUT} = 1.2V, I_{LOAD} = 3.5A, f_{SW} = 1MHz. 20 MHz Bandwidth Limit

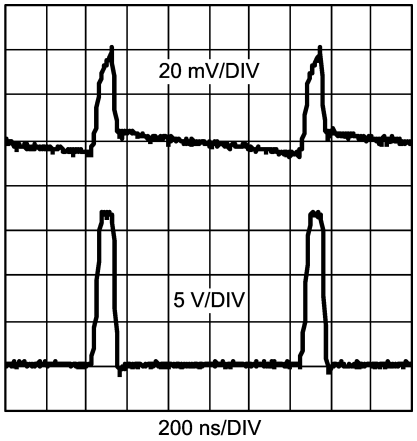

Figure 4. V_{IN} = 14V, V_{CC} = 5V, V_{OUT} = 1.2V, I_{LOAD} = 0A, f_{SW} = 1MHz. 20 MHz Bandwidth Limit

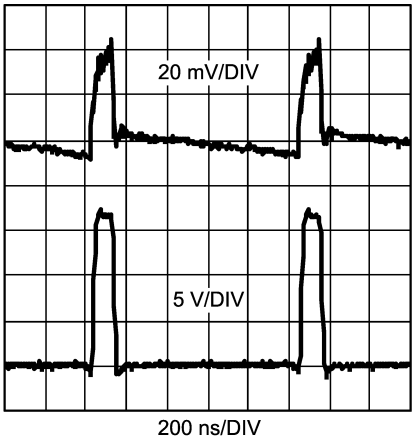

Figure 5. V_{IN} = 14V, V_{CC} = 5V, V_{OUT} = 1.2V, I_{LOAD} = 3.5A, f_{SW} = 1MHz. 20 MHz Bandwidth Limit

Table 1. Bill of Materials

Designator	Function	Part Description	Part Number
U1	Controller	IC LM2743 TSSOP14	Texas Instruments
C5	VCC Decoupling	Cer Cap 1µF 25V 10% 0805	Murata GRM216R61E105KA12B
C7	Soft Start Cap	Cer Cap 12nF 25V 10% 0805	Vishay VJ0805Y123KXX
C8	Comp Cap	Cer Cap 1.5nF 25V 10% 0805	Vishay VJ0805Y152KXX
C9	Comp Cap	Cer Cap 18pF 25V 10% 0805	Vishay VJ0805A180KAA
C10	Cboot	Cer Cap 0.1µF 25V 10% 0805	Vishay VJ0805Y104KXX
C11	Comp Cap	Cer Cap 1.8nF 25V 10% 0805	Vishay VJ0805Y182KXX
C12	Input Filter Cap	Cer Cap 10uF 25V 10% 1210	AVX 12103D106MAT
C14	Input Filter Cap	Cer Cap 10uF 25V 10% 1210	AVX 12103D106MAT
C15	Output Filter Cap	470µF, 6.3V, 10mΩ ESR POScap	Sanyo 6TPD470
R1	Filter Resistor	Res 10Ω .25W 0805	Vishay CRCW08051000F
R2	Frequency Adjust Res	Res 24.9KΩ .25W 0805	Vishay CRCW08052492F
R3	Comp Res	Res 17.4KΩ .25W 0805	Vishay CRCW08051742F
R4	Current Limit Res	Res 3.16KΩ .25W 0805	Vishay CRCW08053161F
R5	Comp Res	Res 2.94KΩ .25W 0805	Vishay CRCW08052941F
R6	Res Divider, upper	Res 10.0KΩ .25W 0805	Vishay CRCW08051002F
R7	Res Divider, lower	Res 10.0KΩ .25W 0805	Vishay CRCW08051002F
R8	PWGD Pull-Up	Res 100KΩ .25W 0805	Vishay CRCW08051003F
R11	Shut Down Pull-Up	Res 100KΩ .25W 0805	Vishay CRCW080561003F
D2	Bootstrap Diode	Schottky Diode, SOD-123	MBR0530LTI
L1	Output Filter Inductor	Inductor 1µH, 5.3Arms, 10.2mΩ	Cooper DR73-1R0
Q1-Q2	Top and Bottom FETs	Dual N-MOSFET, V_{DS} = 20V, 24mΩ @ 2.5V	Vishay 9926BDY

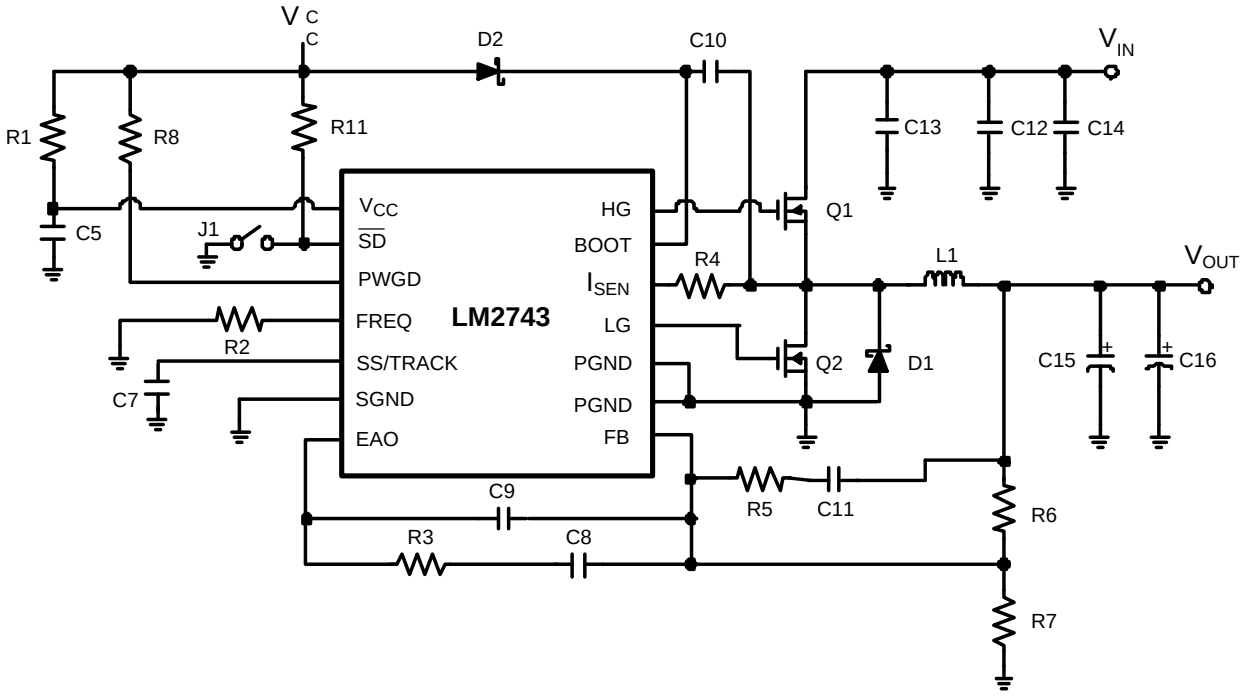

Figure 6. Complete Demo Board Schematic

5 PCB Layout Diagram(s)

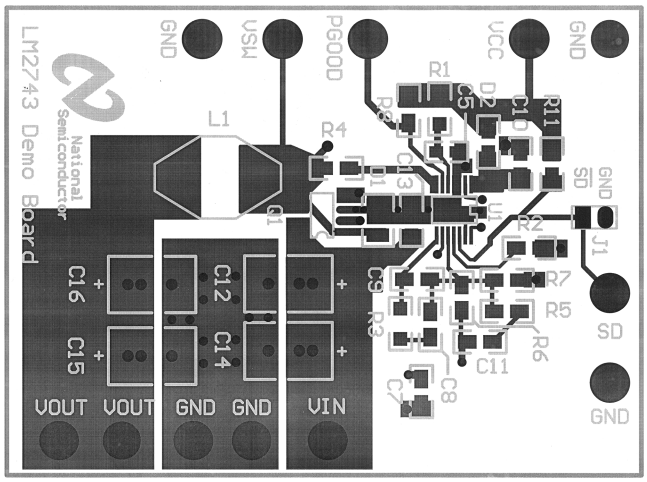

Figure 7. Top Layer and Top Overlay

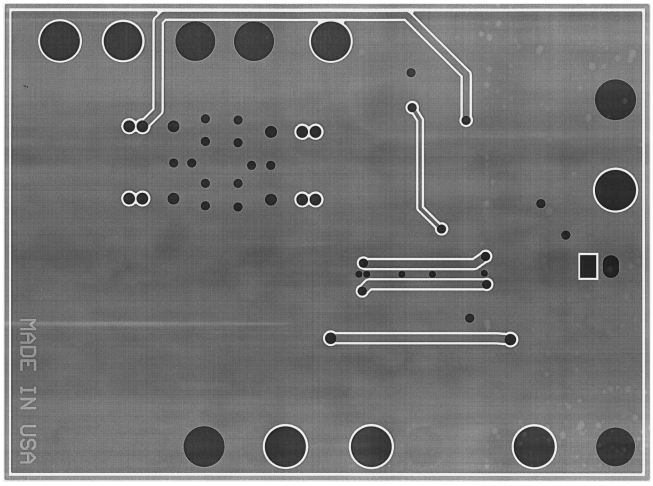

Figure 8. Bottom Layer

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